# Anirudha Behera

abehera1@hawk.iit.edu • Chicago, IL 60608 • +1 (312) 539-8691 • linkedin.com/in/abehera1/ • https://anirudhabehera.site/

### **EDUCATION**

Illinois Institute of Technology, Chicago, USA

Master of Science in Electrical Engineering, GPA 3.53/4.0

Relevant Coursework: Introduction to VLSI, CAD Techniques for VLSI Design, High-Performance VLSI/IC Systems, Digital SoC Design, Computer Organization and Design, RF Integrated Circuit Design

### Gandhi Institute For Technology, Bhubaneswar, India

Bachelor of Technology in Electrical Engineering, GPA: 8.1/10 SKILLS

Scripting/Programming Skills: TCL, Perl, Shell Scripting, Python, VHDL, Verilog

EDA Tools: Synopsys (IC Compiler II, Design Compiler, PrimeTime, Star RC, IC Validator, Hspice, Formality), Cadence (Virtuoso, Encounter), MG/Siemens (Calibre, ModelSim), Xilinx Vivado, CACTI, WATCH, Redhawk

Interpersonal Skills: Project Deadline management, communication skills, multitasking, leadership, quick learning.

### WORK EXPERIENCE

### Research Assistant, Design Automation LAB, IIT, Chicago, USA

- Advisor: Dr. Ken Choi, Professor, ECE Department, IIT Chicago.
- Implemented RTL to GDSII flow for 14nm and 28nm TSMC technology nodes on block-level JBI processor using Synopsys tools.
- Analyzed operating condition variations across design using MCMM and RC corner cases.
- Developed a novel methodology by combining Floorplan and Power plan in one stage for optimizing runtime • and QOR.
- Research Article: Precision Methodology: Transforming VLSI Physical Design with Tailored Floorplan and Power Plan Strategies.

### Physical Design Intern, Chipedge Technology, Remote

- Led end-to-end Physical design phases, Logic Synthesis, Floorplan, Placement, Clock Tree Synthesis (CTS), Routing and Optimization. monitored Quality of Results (QOR) against Power, Performance, and Area (PPA).
- Analyzed Timing/SDC constraints and resolved STA violations through holistic strategies for designs with up to 10 million standard cell instances and over 80 macros across 14nm, 22nm, 32nm and 45nm FinFET/CMOS technology nodes from TSMC.
- Ensured design integrity during Sign-off by extracting parasitic elements (.spef) and progressively resolving DRC, LVS, EM/IR, and LEC issues.
- Employed ECO cycles and extensive manual debugging techniques for successful GDSII tape-out.
- Utilizing Shell and TCL scripting across Physical Design methodology from RTL to GDSII.

### ACADEMIC PROJECTS

OpenSPARC T1 Block Level design from RTL to GDSII using 14nm and 28nm TSMC nodes | DC | ICC2 01/2023

- Used 75% core-area utilization and density sweeps to understand the congestion and routability behavior.
- Optimized design using insertion and size cell techniques to eliminate DRV's like Caps and Trans.

### Standard Cell-Based 32-bit Pipelined CPU Design with Modified New ALU Architecture (RTL to GDSII) 11/2022

- Implemented 5 different CPU models with ASIC flow for slack time optimization.
- Executed Synthesis, PNR, and Opt then recorded optimized slack time, power, area and Obtained GDSII Layout.
- Utilized CSeA, CLA, CRA and CSA adders and comparator-CLA mix designs and compared their performance. 11/2022

### CAD Tool Design for Static Timing Analysis by using TCL/Tk and C Programming

- Designed C code to calculate the required time, arrival time, and slack time from the given input vectors and optimized the code to save the output file separately.
- Designed a Static Timing Analysis CAD tool GUI using TCL/Tk, which can take set of inputs from the user and optimize the given input vector using implemented C code and display the output results on the GUI interface.

Multimedia Mobile Processor Configuration for Ultra-low Power Design | WATCH | CACTI | ModelSim 04/2023

- System-Level: Coded Graph-based slack analysis in C. Optimized with Loop unrolling and catch technique. WATCH and CACTI tools were used. Achieved 85.68% power reduction.
- RTL-Level: Applied ACG, CCG, OCCG, LECG, ECG, hybrid techniques on MMP. Achieved max 109.75% power reduction. Used Formality, Model Sim, Power Compiler (DC) tools.

LEADERSHIP: Secretary General at Eta Kappa Nu Delta Chapter HKN-IEEE Government, IIT-ECE Dept. 01/2023

### 08/2023 - 12/2023

## 10/2022 - 07/2023

# 07/2018

12/2023